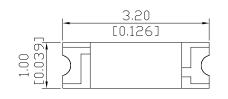


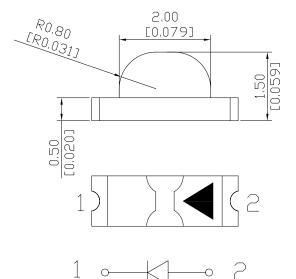
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Feature

- ◆ Viewing angle:160 deg
- The materials of the LED dice is InGaN ٠
- 3.2mm×1.0mm×1.5mm SMT-LED ٠
- RoHS compliant lead-free soldering compatible

Package Outline







OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES

NOTES:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.



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Absolute maximum ratings at Ta=25 $^{\circ}\mathrm{C}$

| Parameter | Symbol | Value | Unit |
|-----------------------------|--------|-----------|------|
| Power dissipation | Pd | 70 | mW |
| Forward current | lf | 20 | mA |
| Reverse voltage | Vr | 5 | V |
| Operating temperature range | Тор | -35 ~+85 | °C |
| Storage temperature range | Tstg | -35 ~+85 | °C |
| Pulse Forward Current | lfp | 100 | mA |
| Electrostatic Discharge | ESD | 1000(HBM) | V |

Electro-optical characteristics at Ta=25 $^{\circ}\mathrm{C}$

| Parameter | Test Condition | Symbol | Value | | | Unit |
|-------------------------|----------------|--------------------|-------|------|-------|---------------------------|
| | | Symbol | Min. | Тур. | Max. | Unit |
| Spectral half bandwidth | lf=20mA | $	riangle \lambda$ | | 30 | | nm |
| Forward voltage | lf=20mA | Vf | 2.8 | | 3.5 | V |
| | | λd | 520 | | 522.5 | nm |
| Dominant wavelength | lf=20mA | | 522.5 | | 525 | nm |
| Dominant wavelength | IT=20mA | | 525 | | 527.5 | nm |
| | | | 527.5 | | 530 | nm |
| | | | 430 | | 530 | nm V nm nm nm |
| Luminous intensity | lf=20mA | lv | 530 | | 650 | mcd |
| | | | 650 | | 800 | mcd |
| Viewing angle at 50% lv | lf=20mA | 2 0 1/2 | | 160 | | Deg |
| Reverse current | Vr=5V | lr | | | 10 | μA |

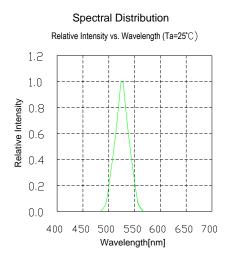
NOTE: (Tolerance: lv ±10%, λ_d ±2nm, Vf ±0.05V)

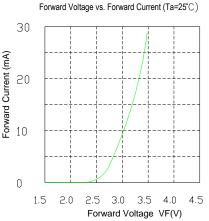
IFP Conditions: Pulse Width \leq 10msec. and Duty $\,\leq$ 1/10.

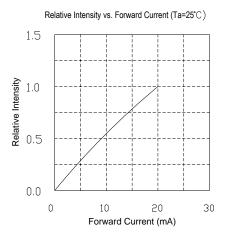


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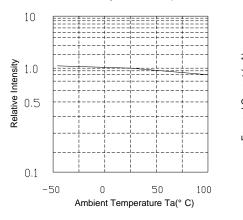
Typical optical characteristics curves

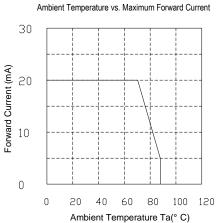






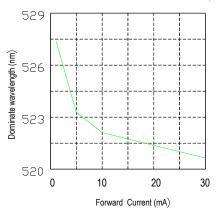
Relative Intensity vs. Ambient Temperature

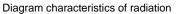


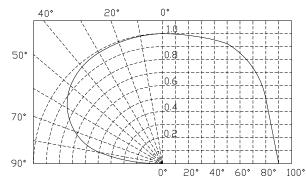


Derating

Forward Current vs. Dominate wavelength (Ta=25°C)







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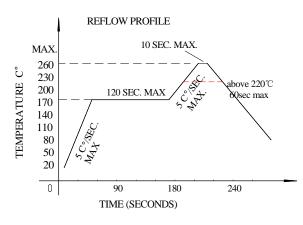
Reflow profile

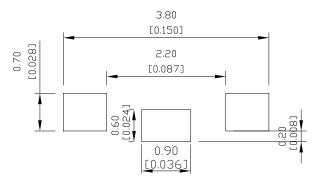
- Soldering condition
 - Recommended soldering conditions

| Reflow Soldering | | Hand Soldering | | |
|------------------|------------------------------|----------------|-----------------|--|
| Pre-heat | 160∼180°C | Temperature | 300°C Max. | |
| Pre-heat time | 120 seconds Max. | | | |
| Peak temperature | 260 ℃ Max. | Soldering time | 3 second Max. | |
| Soldering time | 10 seconds Max. | | (one time only) | |
| Condition | Refer to Temperature-profile | | | |

. . . .

- · After reflow soldering rapid cooling should be avoided
- Temperature-profile (Surface of circuit board) Use the following conditions shown in the figure.



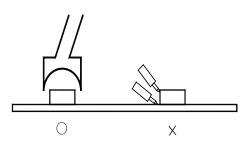


RECOMMEND PAD DESIGN (Units: mm)

- 1. Reflow soldering should not be done more than two times
- 2. When soldering ,do not put stress on the LEDs during heating
- Soldering iron
 - 1. When hand soldering, keep the temperature of the iron under 300 °C, and at that temperature keep the time under 3 sec.
 - 2. The hand soldering should be done only a time
 - 3. The basic spec is <5 sec. when the temperature of 260 °C, do not contact the resin when hand soldering

Rework

- 1. Customer must finish rework within 5 sec under 260 $^\circ\!\mathrm{C}$
- 2. The head of iron can not touch the resin
- 3. Twin-head type is preferred.



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Reliability (1)TEST ITEMS AND RESULTS

| Туре | Test Item | Ref. Standard | Test Conditions | Note | Number of Damaged |
|---------------------------|--|---------------|---|------------|-------------------|
| | Resistance to Soldering Heat(Reflow Soldering) | JESD22-B106 | Tsld=260 ℃,10sec | 2 times | 0/22 |
| nental nce | Temperature Cycle | JESD22-A104 | -40℃ 30min ↑↓5min 100℃ 30min | 1000 cycle | 0/100 |
| Environmental Sequence | Thermal Shock | JESD22-A106 | -40 ℃ 15min ↑↓ 100 ℃ 15min | 1000 cycle | 0/100 |
| | High Temperature Storage | JESD22-A103 | T _a =100℃ | 1000 hrs | 0/100 |
| | Low Temperature Storage | JESD22-A119 | Ta =-40 ℃ | 1000 hrs | 0/100 |
| ation ence | Life Test | JESD22-A108 | T _a =25℃ I _F =20mA | 1000 hrs | 0/100 |
| Operation Sequence | High Humidity Heat Life Test | JESD22-A101 | 60℃ RH=90% I _F =20mA | 1000 hrs | 0/100 |

(2) CRITERIA FOR JUDGING THE DAMAGE

| ltom | Sympol | Symbol Test Conditions | Criteria for | Judgement |
|--------------------|--------|------------------------|--------------|-------------|
| ltem | Symbol | | Min. | Max. |
| Forward Voltage | VF | IF=20mA | _ | U.S.L*)×1.1 |
| Reverse Current | IR | VR=5V | _ | U.S.L*)×2.0 |
| Luminous Intensity | IV | IF=20mA | L.S.L**)×0.7 | _ |

U.S.L.: Upper Standard Level

L.S.L.: Lower Standard Level

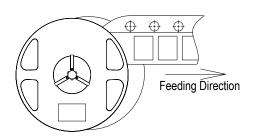


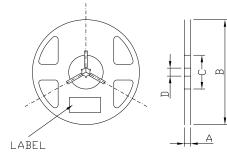
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Packaging Specifications

• Feeding Direction

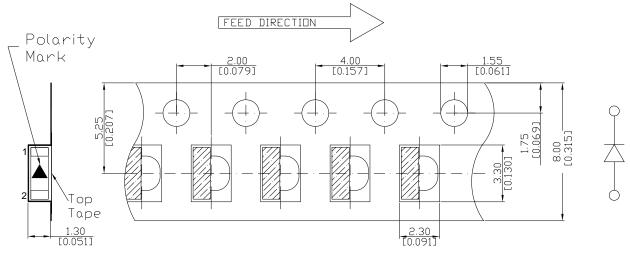
• Dimensions of Reel (Unit: mm)



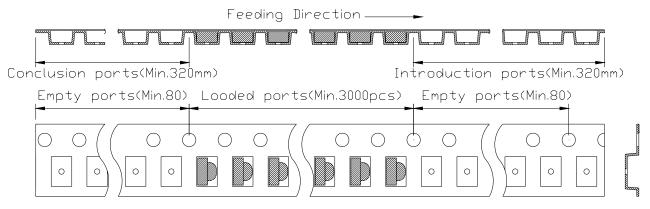


| А | 8.0±0.1mm |
|---|------------|
| В | 178±1mm |
| С | $60\pm1mm$ |
| D | 13.0±0.5mm |

• Dimensions of Tape (Unit: mm)



• Arrangement of Tape



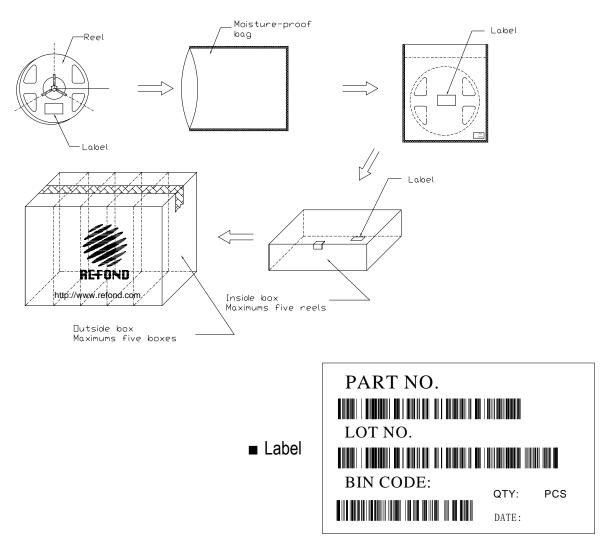
NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 3,000 pcs/ Reel.



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Packaging specifications



CAUTIONS

Package specifications

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Five moisture-proof bag of maximums (total maximum number of products are 15,000pcs) packed in an inside box (size: about 250mm x about 250 x about 68mm) and Five inside boxes of maximums are put the outside box (size: about 360mm x about 265mm x about 255mm) Together with buffer material, and it is packed. (Pare No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has three steps.

Storage conditions

Before opening the package:

The LEDs should be kept at 30° C or less and 70%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package:

The LEDs should be kept at 30 °C or less and 50%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

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